semiconductor and said pattern from said second III-V compound semiconductor expressed by the general formula  $In_xGa_yAl_zN$  where  $0 \le x \le 1$ ,  $0 \le y \le 1$ ,  $0 \le z \le 1$ , and x+y+z=1, wherein the full width at half maximum of the (0004) reflection X-ray rocking curve of said second III-V compound semiconductor is 700 seconds or less regardless of the direction of X-ray incidence, and the compound semiconductor is formed by a vapor phase epitaxy method.

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2. (Amended) A III-V compound semiconductor having a layer formed from a first I/II-V compound semiconductor expressed by the general formula  $In_uGa_vAL_wN$  where  $0\le u\le 1$ ,  $0\le v\le 1$ ,  $0\le w\le 1$ , and u+v+w=1, a pattern formed on said layer from a material different not only from said first III-V compound semiconductor but also from a second III-V compound semiconductor hereinafter described, and a layer formed on said first III-V compound semiconductor and said pattern from said second III-V compound semiconductor expressed by the general formula  $In_xGa_yAl_zN$  where  $0\le x\le 1$ ,  $0\le y\le 1$ ,  $0\le z\le 1$ , and x+y+z=1, wherein an upper surface of said pattern is not in contact with said second III-V compound semiconductor, and the compound semiconductor is formed by a vapor phase epitaxy method.

- 3. (Amended) A III-V compound semiconductor as set forth in claim 1 or 2, wherein said pattern is formed from W or tungsten nitride.
- 4. (Amended) A III-V compound semiconductor as set forth in claim 1 or 2, wherein the first III-V compound semiconductor is expressed by the general formula  $In_uGa_vAL_wN$  where  $0\le u<1$ ,  $0\le v<1$ ,  $0.01\le w\le 1$ , and u+v+w=1.
- 5. (Amended) A III-V compound semiconductor as set forth in claim 1 or 2, wherein said pattern is a lamination comprising at least two layers which are contacting each other and made of different materials.
- 6. (Amended) A III-V compound semiconductor as set forth in claim 1 or 2, wherein said pattern is a lamination comprising at least a layer made of W and a layer made of a material other than W.
- 7. (Amended) A III-V compound semiconductor as set forth in claim 5, wherein said pattern is a lamination comprising at least a layer made of W and a layer made of  $SiO_2$ .

- 8. (Amended) An electronic device comprising the III-V compound semiconductor as set forth in claim 1 or 2.
- 9. (Amended) A light emitting device comprising the III-V compound semiconductor as set forth in claim 1 or 2.

## Please add the following new claim.

--10. (New) A method of making a III-V compound semiconductor comprising:

forming a layer from a first III-V compound semiconductor expressed by the general formula  $In_uGa_vAL_wN$  where  $0\le u\le 1$ ,  $0\le w\le 1$ , and u+v+w=1,

forming a pattern on said layer from a material different not only from said first III-V compound semiconductor but also from a second III-V compound semiconductor,

forming a layer on said first III-V compound semiconductor wherein said pattern from said second III-V compound semiconductor satisfies the general formula  $In_xGa_yAl_zN$  where  $0 \le x \le 1$ ,  $0 \le y \le 1$ ,  $0 \le z \le 1$ , and x+y+z=1, wherein the full width at half maximum of the (0004) reflection X-ray rocking curve of said second III-V compound semiconductor is 700 seconds or less regardless of the direction of X-ray incidence,

wherein the III-V compound semiconductor is formed by a vapor phase epitaxy method.--